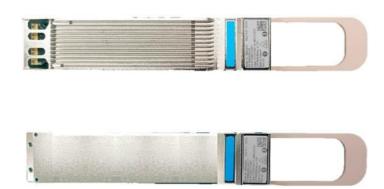


800 Gb/s SR8 OSFP 100 m Transceiver

OSFP Series

- OSFP form factor hot pluggable
- CMIS compliance
- 8 parallel lanes of 100G-PAM4
 electrical and optical parallel
 lanes
- Dual optical port of MPO-12/APC
- Top open fin
- Up to 100m reach on multimode fiber OM4 and 50m on OM3 with FEC
- 14 Watts max
- Case temperature range of 0°C
 to 70°C



Ascent's OSFP-800G-SR8D-01 is 800 Gb/s Octal Small Form-factor Pluggable (OSFP) optical module with top open fin designed for 100 m with OM4 fiber optical communication applications. It is an InfiniBand and Ethernet 800Gb/s, 2x400Gb/s Twin-port OSFP, SR8 multimode, parallel, 8-channel transceiver using two, 4-channel MPO-12/APC optical connectors at 400Gb/s each.

The module converts 8 channels of 100 Gb/s (PAM4) electrical input data to 8 channels of parallel optical signals, each capable of 100 Gb/s operation for an aggregate data rate of 800 Gb/s. Reversely, on the receiver side, the module converts 8 channels of parallel optical signals of 100 Gb/s each channel for an aggregate data rate of 800 Gb/s into 8 channels of 100 Gb/s (PAM4) electrical output data.

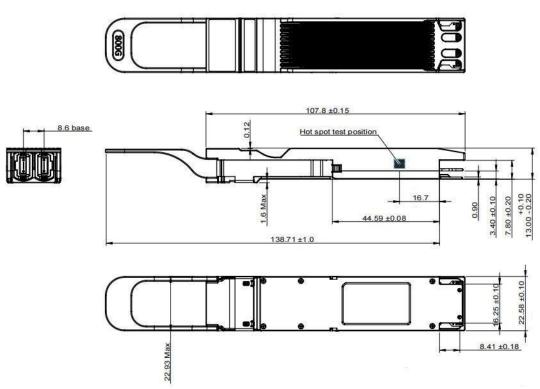
Dual MPO-12 connector can be plugged into the OSFP112 SR8 module receptacle for two sides with 4 channels each. Proper alignment is ensured by the guide pins inside the receptacle. The cable usually cannot be twisted for proper channel to channel alignment. Electrical connection is achieved through an OSFP MSA-compliant edge type connector. I2C interface is supported to read and control the status of this product. It is compatible with various NVIDIA Datacenter Switches.



Key Features -

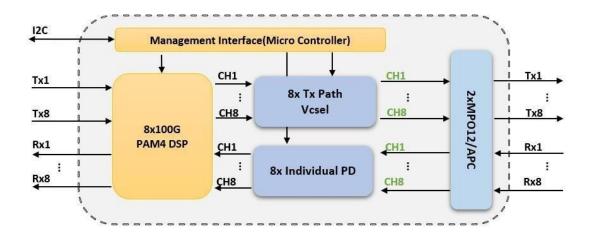
- Compliant with common management interface specifications (CMIS)
- Adaptive Tx input equalization
- Programmable Rx output amplitude, Rx output pre-cursor, Rx output post-cursor
- Supply voltage monitoring (DDM_Voltage)
- Transceiver case temperature monitoring (DDM_Temperature)
- Tx transmit optical power monitoring for each lane (DDM_TxPower)
- Tx bias current monitoring for each lane (DDM_TxBias)
- Rx receive optical power monitoring for each lane (DDM_RxPower)
- Warning and alarm indication for each DDM function
- Tx & Rx LOL and LOS indication, Tx fault indication
- Host and line side loopback capabilities, PRBS generator and checker capabilities
- Versatile diagnostics monitoring (VDM) capability (optional, additional power consumption increase)
- Other functions defined in CMIS

Mechanical Diagram





Transceiver Block Diagram



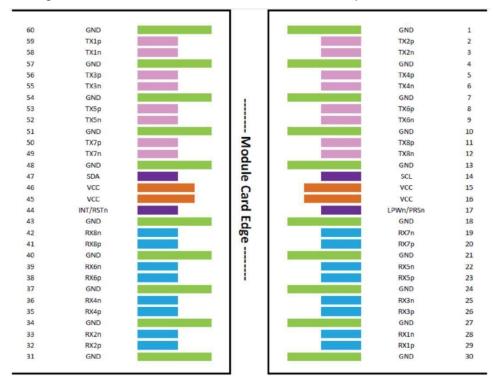
CMIS Application Advertisements

ApSel	Host Electrical Interface	Module Media Interface	Host and Media	Host Lane
Code			Lane Count	Assignment
ApSel 1	50 (400GAUI-4-L C2M)	11 (400GBASE-SR4)	44 (4:4)	11 (lanes 1, 5)
ApSel 2	32 (IB NDR)	11 (400GBASE-SR4)	44 (4:4)	11 (lanes 1, 5)
ApSel 3	F (200GAUI-4 C2M)	E (200GBASE-SR4)	44 (4:4)	11 (lanes 1, 5)
ApSel 4	31 (IB HDR)	E (200GBASE-SR4)	44 (4:4)	11 (lanes 1, 5)
ApSel 5	4C (100GAUI-1-L C2M)	D (100GBASE-SR)	11 (1:1)	FF (lanes 1, 2,
				3, 4, 5, 6, 7, 8)
ApSel 6	52 (800GAUI-8-L C2M)	12 (800G-SR8)	88 (8:8)	01 (lane 1)
ApSel 7	4F (400GAUI-4-S C2M)	11 (400GBASE-SR4)	44 (4:4)	11 (lanes 1, 5)
				FF (lanes 1, 2,
ApSel 8	4B (100GAUI-1-S C2M)	D (100GBASE-SR)	11 (1:1)	3, 4, 5, 6, 7, 8)
ApSel 9	51 (800GAUI-8-S C2M)	12 (800G-SR8)	88 (8:8)	01 (lane 1)
ApSel 10	42 (CAUI-4 C2M with RS FEC)	9 (100GBASE-SR4)	44 (4:4)	11 (lanes 1, 5)
ApSel 11	30 (IB EDR)	9 (100GBASE-SR4)	44 (4:4)	11 (lanes 1, 5)



Pin Assignment -

The electrical interface of OSFP module consist of a 60 contacts edge connector as illustrated by the diagram in the figure below, which is defined in Clause 8.1 of OSFP MSA Specification.



Pin#	Symbol	Description	Logic	Direction	Plug Sequence
1	GND		Ground		1
2	TX2p	Transmitter Data Non-Inverted	CML-I	Input from Host	3
3	TX2n	Transmitter Data Inverted	CML-I	Input from Host	3
4	GND		Ground		1
5	TX4p	Transmitter Data Non-Inverted	CML-I	Input from Host	3
6	TX4n	Transmitter Data Inverted	CML-I	Input from Host	3
7	GND		Ground		1
8	TX6p	Transmitter Data Non-Inverted	CML-I	Input from Host	3
9	TX6n	Transmitter Data Inverted	CML-I	Input from Host	3
10	GND		Ground		1
11	TX8p	Transmitter Data Non-Inverted	CML-I	Input from Host	3
12	TX8n	Transmitter Data Inverted	CML-I	Input from Host	3
13	GND		Ground		1
14	SCL	2-wire Serial interface clock	LVCMOS-I/O	Bi-directional	3
15	VCC	+3.3V Power		Power from Host	2
16	VCC	+3.3V Power		Power from Host	2
17	LPWn/PRSn	Low-Power Mode / Module Present	Multi-Level	Bi-directional	3
18	GND		Ground		1
19	RX7n	Receiver Data Inverted	CML-O	Output to Host	3



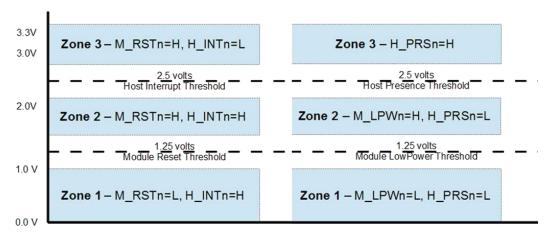
Pin#	Symbol	Description	Logic	Direction	Plug Sequence
20	RX7p	Receiver Data Non-Inverted	CML-O	Output to Host	3
21	GND		Ground		1
22	RX5n	Receiver Data Inverted	CML-O	Output to Host	3
23	RX5p	Receiver Data Non-Inverted	CML-O	Output to Host	3
24	GND		Ground		1
25	RX3n	Receiver Data Inverted	CML-O	Output to Host	3
26	RX3p	Receiver Data Non-Inverted	CML-O	Output to Host	3
27	GND		Ground		1
28	RX1n	Receiver Data Inverted	CML-O	Output to Host	3
29	RX1p	Receiver Data Non-Inverted	CML-O	Output to Host	3
30	GND		Ground		1
31	GND		Ground		1
32	RX2p	Receiver Data Non-Inverted	CML-O	Output to Host	3
33	RX2n	Receiver Data Inverted	CML-O	Output to Host	3
34	GND		Ground		1
35	RX4p	Receiver Data Non-Inverted	CML-O	Output to Host	3
36	RX4n	Receiver Data Inverted	CML-O	Output to Host	3
37	GND		Ground		1
38	RX6p	Receiver Data Non-Inverted	CML-O	Output to Host	3
39	RX6n	Receiver Data Inverted	CML-O	Output to Host	3
40	GND		Ground		1
41	RX8p	Receiver Data Non-Inverted	CML-O	Output to Host	3
42	RX8n	Receiver Data Inverted	CML-O	Output to Host	3
43	GND		Ground		1
44	INT/RSTn	Module Interrupt / Module Reset	Multi-Level	Bi-directional	3
45	VCC	+3.3V Power		Power from Host	2
46	VCC	+3.3V Power		Power from Host	2
47	SDA	2-wire Serial interface data	LVCMOS-I/O	Bi-directional	3
48	GND		Ground		1
49	TX7n	Transmitter Data Inverted	CML-I	Input from Host	3
50	TX7p	Transmitter Data Non-Inverted	CML-I	Input from Host	3
51	GND		Ground		1
52	TX5n	Transmitter Data Inverted	CML-I	Input from Host	3
53	TX5p	Transmitter Data Non-Inverted	CML-I	Input from Host	3
54	GND		Ground		1
55	TX3n	Transmitter Data Inverted	CML-I	Input from Host	3
56	TX3p	Transmitter Data Non-Inverted	CML-I	Input from Host	3
57	GND		Ground		1
58	TX1n	Transmitter Data Inverted	CML-I	Input from Host	3
59	TX1p	Transmitter Data Non-Inverted	CML-I	Input from Host	3
60	GND		Ground		1



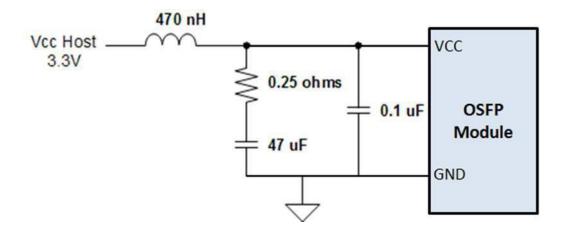
OSFP Control Pins

Name	Direction	Description
SCL	BiDir	2-wire serial clock signal. Requires pull-up resistor to 3.3V on host
SDA	BiDir	2-wire serial data signal. Requires pull-up resistor to 3.3V on host.
LPWn/PRSn	Input/Output	Dual Function Signal
		. Low Power mode is an active-low input signal
		. Module Present is controlled by a pull-down resistor on the module which
		gets converted to an active-low output logic signal
		Voltage zones is shown as figure3.
INT/RSTn	Input/Output	Dual Function Signal
		. Reset is an active-low input signal
		. Interrupt is an active-high output signal Voltage zones is shown as figure 3.

Voltage Zones



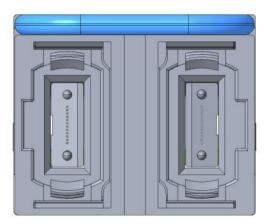
Recommended Power Supply Filter





Optical Port Description -

The optical interface port is dual MPO-12 APC receptacle. The transmit and receive optical lanes shall occupy the positions depicted in Figure 5 when looking into the MDI receptacle with the connector keyway feature on top.



Optical Media Dependent Interface port assignments

ESD

This transceiver is specified as ESD threshold 1kV for high-speed data pins and 2kV for all other electrical input pins, tested per MIL-STD-883, Method 3015.4 /JESD22-A114-A (HBM). However, normal ESD precautions are still required during the handling of this module. This transceiver is shipped in ESD protective packaging. It should be removed from the packaging and handled only in an ESD protected environment.



Specifications -

Absolute Maximum Ratings

It has to be noted that the operation in excess of any individual absolute maximum ratings might cause permanent damage to this module.

Parameter	Symbol	Min.	Max.	Units	Note
Storage Temperature	Ts	-40	85	°C	
Operating Case Temperature	T _{OP}	0	70	°C	
Power Supply Voltage	Vcc	-0.5	3.6	V	
Relative Humidity	RH	0	85	%	Non-condensing

Recommended Operating Conditions

Parameter	Symbol	Min.	Тур.	Max.	Units	Note
Operating Case Temperature	T _{OP}	0		70	°C	
Power Supply Voltage	V _{CC}	3.135	3.3	3.465	V	
Data Rate, each Lane			53.125		GBd	PAM4
Data Rate Accuracy		-100		100	ppm	
Pre-FEC Bit Error Ratio				2.4x10 ⁻⁴		
Post-FEC Bit Error Ratio				1x10 ⁻¹⁵		1
Link Distance (OM4)	D1	2		100	m	2
Link Distance (OM3)	D2	2		50	m	2

Notes:

- 1. FEC provided by host system.
- 2. FEC required on host system to support maximum distance.

Electrical Characteristics

The following electrical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

Parameter	Symbol	Min.	Тур.	Max.	Units	Note
Power Consumption				14	W	
Supply Current	Icc			4.24	Α	
Module Input (each Lane)						
Signaling Rate, each Lane	TP1	5325 ppm ± 100	ppm		GBd	
DC Common-Mode Input Voltage	TP1	-0.35		2.85	V	
Single-Ended Input Voltage	TP1a	-0.4		3.3	V	
AC Common-Mode Voltage	TP1a				mV	
Tolerance						
Low-Frequency, VCM _{LF}		32				
Full-Band, VCM _{LF}		80				
Module Stressed Input Tolerance	TP1a	IEEE 802.3ck D3.3	3 120G.3	.4.3		
Differential Peak-to-Peak Input	TP1a	750			mV	
Voltage Tolerance						
Differential to Common-Mode	TP1	IEEE 802.3ck D3.3	3		dB	
Return Loss, RLcd		Equation 120G-2				



Parameter	Symbol	Min.	Тур.	Max.	Units	Note
Effective Return Loss, ERL	TP1	8.5				
Differential Termination Mismatch	TP1			10		
Signaling Rate, Each Lane	TP4	53.125 ± 100 ppr	m			
Peak-to-Peak AC Common-Mode Voltage	TP4					
Low-Frequency, VCMLF				32		
Full-Band, VCMLF				80		
Differential Peak-To-Peak Output	TP4				mV	
Voltage						
Short Mode				600		
Long Mode				845		
Eye Height	TP4	15			mV	
Vertical Eye Closure, VEC	TP4			12	dB	
Common-Mode to Differential	TP4	IEEE 802.3ck Equ	ıation		dB	
Return		120G-1				
Loss, Rldc						
Effective Return Loss, ERL	TP4	8.5			dB	
Differential Termination	TP4			10	%	
Mismatch						
Transition Time	TP4	8.5			ps	
DC Common-Mode Voltage Tolerance	TP4	-0.35		2.85	V	

Optical Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Units	Note
Transmitter						
Data Rate, each Lane		53.125 ± 100 pp	m		GBd	
Modulation Format		PAM4				
Center Wavelength	λc	844	850	863	nm	
RMA Spectral Width				0.6	nm	
Average Launch Power, each Lane	P _{AVG}	-4.6		4	dBm	1
Outer Optical Modulation	P_{OMA}			3.5	dBm	
Amplitude (OMA _{outer}), each Lane						
For max(TECQ, TDECQ) ≤ 1.8 dB		-2.6				
For $1.8 < max(TECQ, TDECQ) \le 4.4$	ļ.	-4.4+ max				
dB		(TECQ,TDECQ)				
Transmitter and Dispersion Eye	TDECQ			4.4	dB	
Closure for PAM4 (TDECQ), each Lane						
Transmitter Eye Closure for	TECQ			4.4	dB	
PAM4, each Lane					U. 2	
Overshoot/Undershoot			29		%	
Transmitter Power Excursion			2.3		dBm	
Extinction Ratio	ER	2.5			dB	
Transmitter Transition Time	Toff		17		ps	
Average Launch Power			-30		dBm	
of OFF Transmitter						



Parameter	Symbol	Min.	Тур.	Max.	Units	Note
RIN ₁₄ OMA	RIN			-132	dB/Hz	
Optical Return Loss Tolerance	TOL			14	dB	
Encircled Flux		≥ 86% at 19µm			dB	2
		≤ 30% at 4.5 µm				
Receiver						
Data Rate, each Lane		53.125 ± 100 ppm			GBd	
Modulation Format		PAM4				
Center Wavelength	λc	842	850	948	nm	
Damage Threshold, each Lane	THd	5			dBm	3
Average Receive Power, each		-6.4		4	dBm	4
Lane						
Receive Power (OMA _{outer}), each				3.5	dBm	
Lane Receiver Sensitivity (OMA _{outer}),	SEN			-4.6, TECQ	dBm	5
each Lane	JLIV			- 6.4	abiii	3
Stressed Receiver Sensitivity (OMA _{outer}), each Lane	SRS			-2.0	dBm	6
Receiver Reflectance	RR		-15		dB	
LOS Assert	LOSA	-15	-8.6		dBm	
LOS De-assert	LOSD		-6.6		dBm	
LOS Hysteresis	LOSH	0.5			dB	
Conditions of Stress Receiver Ser	nsitivity T	est (Note 7)				
Stressed Eye Closure for PAM4 (SECQ), Lane under Test			4.4		dB	
OMA _{outer} of each Aggressor Lane			3.5		dB	

Notes:

- 1. Average launch power, each lane (min) is informative and not the principal indicator of signal strength. A transmitter with launch power below this value cannot be compliant; however, a value above this does not ensure compliance.
- 2. If measured into type A1a.2 or type A1a.3, or A1a.4, 50 μm fiber, in accordance with IEC 61280-1-4.
- 3. The receiver shall be able to tolerate, without damage, continuous exposure to a modulated optical input signal having this power level on one lane. The receiver does not have to operate correctly at this input power.
- 4. Average receive power, each lane (min) is informative and not the principal indicator of signal strength. A received power below this value cannot be compliant; however, a value above this does not ensure compliance.
- 5. Measured with conformance test signal at TP3 for the BER equal to 2.4x10-4.
- 6. These test conditions are for measuring stressed receiver sensitivity. They are not characteristics of the receiver.



Digital Diagnostic Specifications

The following digital diagnostic characteristics are defined over the normal operating conditions unless otherwise specified.

Parameter	Symbol	Min.	Max.	Units	Notes
Temperature Monitor Absolute Error	DMI_Temp	-3	3	°C	Over operating temperature range
Supply Voltage Monitor Absolute Error	DMI_VCC	-0.1	0.1	V	Over full operating range
Channel RX Power Monitor Absolute Error	DMI_RX_Ch	-2	2	dB	1
Channel Bias Current Monitor	DMI_Ibias_Ch	-10%	10%	mA	
Channel TX Power Monitor Absolute Error	DMI_TX_Ch	-2	2	dB	1

Notes:

1. Due to measurement accuracy of different single mode fibers, there could be an additional ± 1 dB fluctuation, or a ± 3 dB total accuracy.

Ordering Information

Product Name	Product Description
OSFP-800G-SR8D-01	OSFP-800G-SR8 NVIDIA twin port transceiver, 800 Gbps, 2xNDR, OSFP,
	2xMPO12 APC, 850 nm MMF, up to 100 m, finned



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